PNP -3.0A -30V Middle Power Transistor

Parameter	Value
V _{CEO}	-30V
Ic	-3A

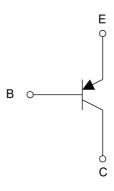
Outline



Features

- 1) Suitable for Middle Power Driver.
- 2) Low $V_{CE(sat)}$ $V_{CE(sat)}$ =-0.20V(Max.). (I_C/I_B =-1A/-50mA)
- 3) High collector current. I_C=-3A(max),I_{CP}=-6A(max)
- 4) Leadless small SMD package (HUML2020L3) Excellent thermal and electrical conductivity.
- 5) Lead Free/Rohs Compliant.

•Inner circuit



B: BASE

C: COLLECTOR E: EMITTER

Application

Motor driver,LED driver Power supply

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SAR542F3	HUML2020L3	2020	TR	180	8	3000	MQ

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	-30	V
Collector-emitter voltage	V _{CEO}	-30	V
Emitter-base voltage	V _{EBO}	-6	V
Callandari suggest		-3	Α
Collector current	I _{CP} *1	-6	-6 A
Base current	I _B	-500	mA
Davis dia sin etia s		1.0	W
Power dissipation	P _D *3	2.1	W
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Doromator	Symbol	Conditions	Values			Lloit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	I _C = -100μA	-30	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-30	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	I _E = -100μA	-6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -30V	-	-	-100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -4V	-	-	-100	nA
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -1A$, $I_B = -50mA$	-	-90	-200	mV
DC current gain	h _{FE}	$V_{CE} = -2V, I_{C} = -500 \text{mA}$	200	-	500	-
Transition frequency	f _T	V _{CE} = -10V, I _E = 100mA, f = 100MHz	1	240	-	MHz
Output capacitance	C_ob	$V_{CB} = -10V$, $I_E = 0mA$, $f = 1MHz$	-	40	-	pF
Turn-On time	t _{on} *4	I _C = -2.5A, V _{CC} = -10V	-	45	-	ns
Storage time	t _{stg} *4	I _{B1} = -250mA	-	200	-	ns
Fall time	t _f *4	I _{B2} = 250mA	-	25	-	ns

^{*1} Pw=1ms 1PULSE

^{*2} Mounted on FR4 board(25.4×25.4×1.6mm, Cu PAD:645mm²).

^{*3} Pw=10ms Mounted on FR4 board(25.4×25.4×1.6mm, Cu PAD:645mm²).

^{*4} SEE SWITCHING TIME TEST CIRCUIT

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

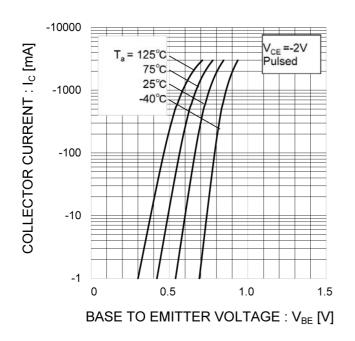
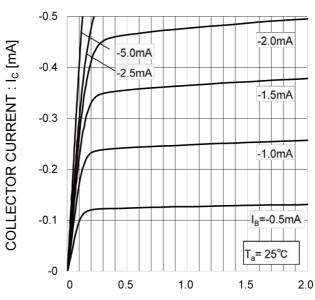


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current(I)

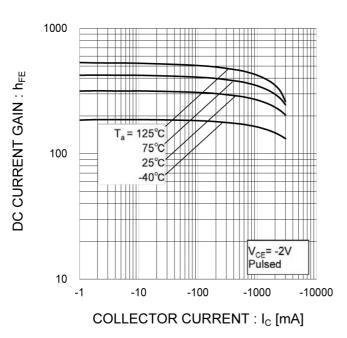
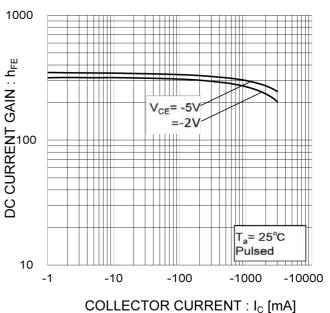


Fig.4 DC Current Gain vs. Collector Current(II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs.

Collector Current(I)

COLLECTOR CURRENT : I_C [mA]

Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

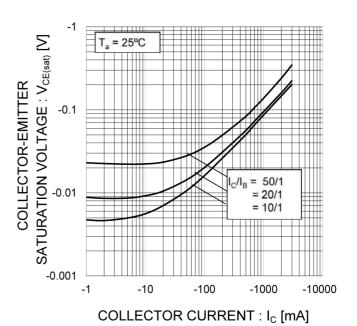


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

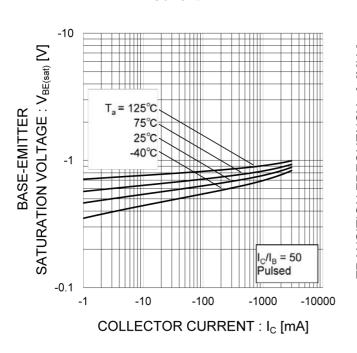
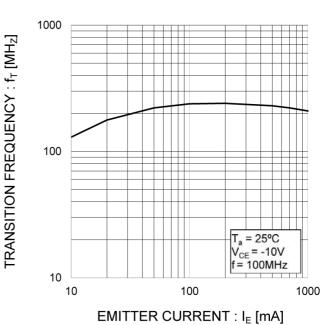


Fig.8 Gain Bandwidth Product vs. Emitter Current



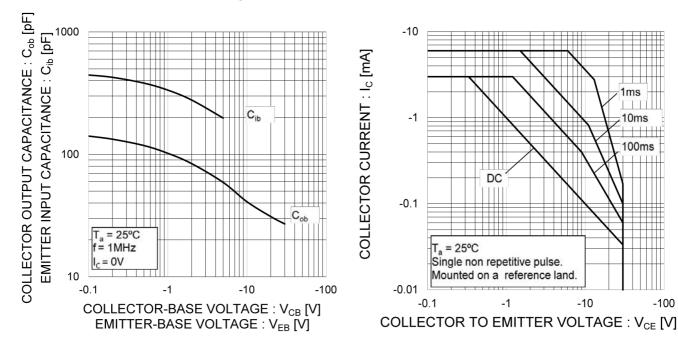
10ms

100ms

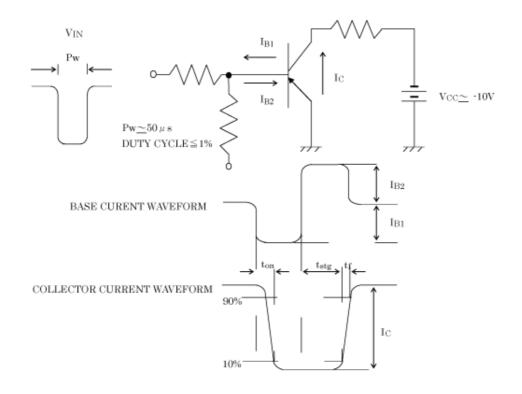
● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter input capacitance vs. Emitter=Base Voltage Collector output capacitance vs. Collector-Base Voltage

Fig.10 Safe Operating Area

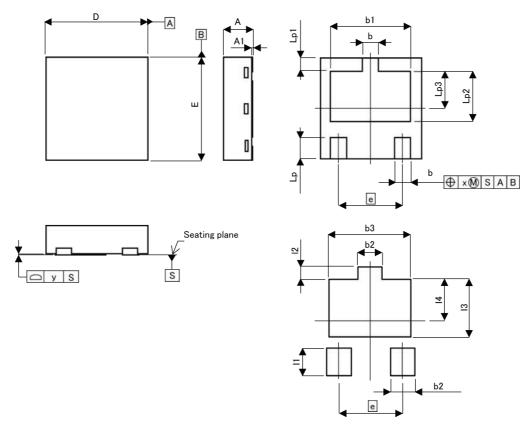


SWITCHING TIME TEST CIRCUIT



Dimensions

HUML2020L3



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIME	TERS	INCHES	
	MIN	MAX	MIN	MAX
Α	0.55	0.65	0.022	0.026
A1	0.00	0.05	0.000	0.002
b	0.25	0.35	0.010	0.014
b1	1.40	1.60	0.055	0.063
D	1.90	2.10	0.075	0.083
E	1.90	2.10	0.075	0.083
е	1.3	30	0.0)51
Lp	0.35	0.45	0.014	0.018
Lp1	0.25	REF	0.01	REF
Lp2	0.90	1.10	0.035	0.043
Lp3	0.70	0.80	0.028	0.031
x	<u> </u>	0.10	-	0.004
٧	-	0.10		0.004

DIM	MILIME	ETERS	INCHES		
	MIN	MAX	MIN	MAX	
b2	-	0.45	-	0.018	
b3	2	1.60	-	0.063	
11	2	0.55	-	0.022	
12	0.25	REF	0.01	REF	
13	-	1.10	-	0.043	
14	8	0.80	2	0.031	

Dimension in mm/inches



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